

±15 Volt Chopper Stabilized Operational Amplifier

General Description

The MAX420, 421, 422, and 423 are a series of $\pm 15 V$ CMOS chopper-stabilized amplifiers, designed for high accuracy amplification, signal conditioning and instrumentation applications. These devices offer input offset and drift specification superior to previous "precision" bipolar amplifiers and monolithic choppers. The maximum offset is $5.0\,\mu V$ while the guaranteed drift limit is $0.05\mu V/^{\circ}C$.

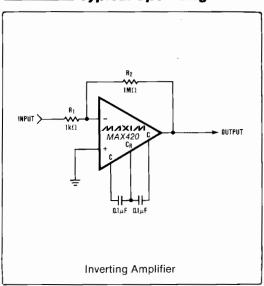
The combination of ± 15 volt operation, low power, and standard op-amp pin configuration allows these devices to virtually "plug-in" replace conventional lower-performance amplifiers. The only additional components required are two external capacitors. A wide input voltage range specification, that includes the negative supply, allows for the amplification of signals including ground in single-supply applications.

The MAX420 (8 pin) and MAX421 (14 pin) have a maximum supply current of 2mA. The MAX422 (8 pin) and MAX 423 (14 pin) are low power amplifiers with a maximum current of 0.5mA.

Applications

Precision Amplifiers
Signal Conditioning for:
Thermocouples
Strain Gauges, Load Cells
Platinum Temperature Sensors
Thermistors, Bridges
High Accuracy Data Acquisition
D.C. Stabilization of Amplifiers and Systems

Typical Operating Circuit



Features

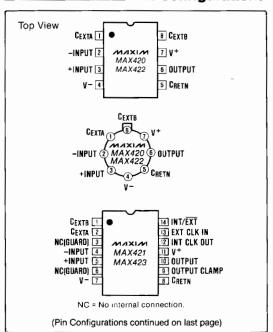
- 5μV Max Offset Voltage
- ♦ ±15V Supply Operation
- ♦ Input Voltage Range: +11V to -15V
- ★ Low Input Noise: 0.3μV_{D-D} (DC 1Hz)
- ♦ High Gain, CMRR, PSRR: 120dB
- Low Power CMOS Design: 0.5mA Max Supply Current (MAX422/423)
- ◆ Low Input Bias Current: 30pA Max

Ordering Information

PART	TEMP. RANGE	PACKAGE		
MAX420CPA	0°C to +70°C	8 Lead Plastic DIP		
MAX420EPA	-40°C to +85°C	8 Lead Plastic DIP		
MAX420MTV	-55°C to +125°C	TO-99 Metal Can		
MAX421CPD	0°C to +70°C	14 Lead Plastic DIP		
MAX421CWE	0°C to +70°C	16 Lead Small Outline		
MAX421C/D	0°C to +70°C	Dice		
MAX421EPD	-40°C to +85°C	14 Lead Plastic DIP		
MAX421MJD	-55°C to +125°C	14 Lead CERDIP		

(Ordering information continued on last page)

Pin Configurations



ABSOLUTE MAXIMUM RATINGS

Total Supply Voltage (V* to V-)	Current Into Any Pin 10mA
Input Voltage (V+ + 0.3) to (V 0.3) V	Continuous Total Power Dissipation (T _A = +25°C)
Storage Temperature Range65°C to +160°C	CERDIP Package 500mW
Operating Temperature Range See Note 1	Plastic Package 375mW
Lead Temperature (Soldering, 10 sec) +300°C	TO-99 250mW
Voltage on Oscillator Control Pins V+ to V-	
Duration of Output Short Circuit Indefinite	

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS MAX420, MAX421 (V $^+$ = +15V, V $^-$ = -15V, T_A = +25 $^\circ$ C. Test circuit unless noted.)

PARAMETER	SYMBOL	CONDITIO	NS		MIN.	TYP.	MAX.	UNITS
Input Offset Voltage	V	T _A = +25°C		C E,M		±1 ±1	±10 ±5	μV
Imput Offset Voltage	Vos	Over Temperature Range (Note 1, 2)		C E,M		±2 ±2	±20 ±10	μV
Average Temperature Coefficient of Input Offset Voltage	<u>77</u>	Over Temperature Range (Note 1, 2)		E,M		0.02	0.05	μV/°C
		T _A = +25°C		C E,M		10 10	100 30	pA
Input Bias Current	IB	Over Temperature Range (Note 1)		C E M		30 35 0.5	5	pA pA nA
Input Offset Current I _O		T _A = +25°C		C E,M		15 15	200 60	pA
	I _{os}	Over Temperature Range (Note 1)		C E M		30 50 0.5	10	pA pA nA
Input Resistance	R _{IN}					10 ¹²		Ω
Large Signal Voltage Gain	A _{VOL}	$R_L = 10k\Omega$, $V_{OUT} = \pm 10$ Over Temperature Ran	V, T _A = +2	25°C e 1)	120 120	150 150		dB
Output Voltage Swing	V _{OUT}	CLAMP not connected (note 3)	R _L = 1 R _L = 1		±12	±14.5 ±14.95		V
Common-Mode Voltage Range	CMVR		•		+11, -15	+11.5, -15.1		V
Common-Mode Rejection Ratio	CMRR	CMVR = +11V to -15V, Over Temperature Range			120 110	140 140		dB
Power Supply Rejection Ratio	PSRR	±3V to ±16.5V, T _A = 25°C Over Temperature Range (Note 1)		e 1)	120 110	140 140		dB
Input Noise Voltage (P-P value not exceeded 95% of time)	e _{Np-p}	R _S = 100Ω, DC to 1Hz DC to 10 H				0.3 1.1		μV_{p-p}
Input Noise Current	IN	f = 10Hz				0.01		pA/√Hz
Unity-Gain Bandwidth -	GBW					500		kHz
Slew Rate	SR	$C_L = 50 pF, R_L = 10 k\Omega$				0.5		V/µs
Rise Time	t _r					0.7	-	μS
Overshoot						20		%

Operating temperature range for "C" parts is 0°C to +70°C, for "E" parts is -40°C to +85°C, and for "M" parts is -55°C to +125°C.

Note 2: Operating entire range for C parts is 0.50 to +70.5, for E parts is -40.5 to +65.5, and for M parts is -55.5 to +125.5.

Note 3: The OUTPUT CLAMP, pin 9 on MAX421, when connected to the inverting input (pin 4), reduces the overload recovery time inherent with chopper-stabilized amplifiers (see text).

Note 4: All pins are designed to withstand electrostatic discharge (ESD) levels in excess of 2000V (Mil Std 883C, Method 3015.2 Test

ELECTRICAL CHARACTERISTICS MAX420, MAX421 (continued)

(V* = +15V, V- = -15V, T_A = +25°C. Test circuit unless noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating Supply Range	V+, V-		±2.5		±16.5	V
Supply Current	Is	No Load, T _A = +25°C Over Temperature Range (Note 1)		1.3	2.0 3.5	mA
Internal Chopping Frequency	f _{ch}	Pins 12-14 Open (MAX421)		400		Hz
Clamp ON Current (Note 3)	I _{CLP (ON)}	$R_L = 100k\Omega$	25	100		μА
Clamp OFF Current (Note 3)	CLP (OFF)	-10V ≤ V _{OUT} ≤ +10V		1		pA
Offset Voltage vs. Time				100		nV/√mont

Note 1: Operating temperature range for "C" parts is 0°C to +70°C, for "E" parts is -40°C to +85°C, and for "M" parts is -55°C to +125°C.

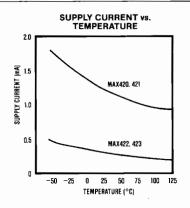
Note 2: Guaranteed by design.

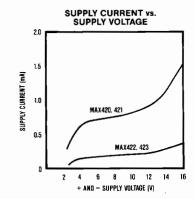
Note 3: The OUTPUT CLAMP, pin 9 on MAX421, when connected to the inverting input (pin 4), reduces the overload recovery time

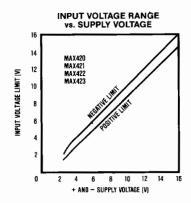
inherent with chopper-stabilized amplifiers (see text).

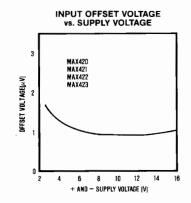
Note 4: All pins are designed to withstand electrostatic discharge (ESD) levels in excess of 2000V (Mil Std 883C, Method 3015.2 Test Circuit).

Typical Operating Characteristics









ABSOLUTE MAXIMUM RATINGS: same as for MAX420, 421 **ELECTRICAL CHARACTERISTICS MAX422, MAX423**

PARAMETER	SYMBOL	CONDITIONS		MIN.	TYP.	MAX.	UNITS
		T _A = +25°C	C E,M		±1 ±1	±10 ±5	μV
Input Offset Voltage	V _{OS}	Over Temperature Range (Note 1, 2)	C E,M		±2 ±2	±20 ±10	μV
Average Temperature Coefficient of Input Offset Voltage	77 _{OS}	Over Temperature Range (Note 1, 2)	E,M		0.02	0.05	μV/°C
Input Bias Current	I _B	T _A = +25°C	C E,M		10 10	100 30	pΑ
(Doubles every 10°C above about 60°C)		Over Temperature Range (Note 1)	C E M		30 35 0.5	5	pA pA nA
Input Offset Current		T _A = +25°C	C E,M		15 15	200 60	pA
(Doubles every 10°C above about 60°C)	los	Over Temperature Range (Note 1)	C E M		30 50 0.5	10	pA pA nA
Input Resistance	R _{IN}				1012		Ω
Large Signal Voltage Gain	A _{VOL}	R _L = 100kΩ, V _{OUT} = ±10V, T _A = - Over Temperature Range (Not	R _L = 100k(), V _{OUT} = ±10V, T _A = +25°C Over Temperature Range (Note 1)		150 150		dB
Output Voltage Swing	V _{OUT}	CLAMP not connected (Note 3) R _L = 100kΩ		±14	±14.6		V
Common-Mode Voltage Range	CMVR			+11, -15	+11.5, -15.1		V
Common-Mode Rejection Ratio	CMRR	CMVR = +11V to -15V, TA = +2 Over Temperature Range (Note		120 110	140 140		dB
Power Supply Rejection Ratio	PSRR	±3V to ±16.5V, T _A = +25°C Over Temperature Range (Note 1)		120 110	140 140		dB
Input Noise Voltage (P-P value not exceeded 95% of time)	e _{Np-p}	R _S = 100Ω, DC to 1Hz DC to 10Hz			0.4		μV_{p-p}
Input Noise Current	IN	f = 10Hz			0.01		pA/√H
Unity-Gain Bandwidth	GBW				125		kHz
Slew Rate	SR	C _L = 50pF, R _L = 100kΩ			1.25		V/μs
Rise Time	t _r				2.8		μS
Overshoot					20		%
Operating Supply Range	V+, V-			±2.5		±16.5	V
Supply Current	ıs	No Load, T _A = +25°C Over Temperature Range (Note 1)			0.3	0.5 1	mA
Internal Chopping Frequency	f _{ch}	Pins 12-14 Open (MAX423)			250		Hz
Clamp ON Current (Note 3)	I _{CLP} (ON)	$R_L = 1M\Omega$		5	25		μА
Clamp OFF Current (Note 3)	I _{CLP} (OFF)	-10V ≤ V _{OUT} ≤ +10V			1		pA
Offset Voltage vs. Time					100		nV/√moi

Note 1: Operating temperature range for "C" parts is 0°C to +70°C, for "E" parts is -40°C to +85°C, and for "M" parts is -55°C to +125°C.

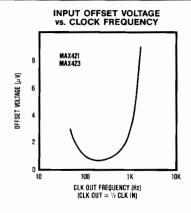
Note 2: Guaranteed by design.

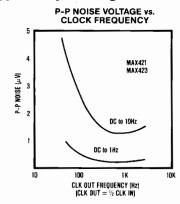
Guaranteed by design.
The OUTPUT CLAMP, pin 9 on MAX423, when connected to the inverting input (pin 4), reduces the overload recovery time Note 3: inherent with chopper-stabilized amplifiers (see text).

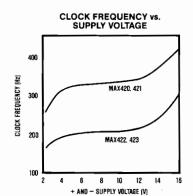
Note 4: All pins are designed to withstand electrostatic discharge (ESD) levels in excess of 2000V (Mil Std 883C, Method 3015.2 Test

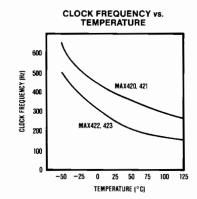


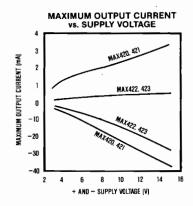
Typical Operating Characteristics

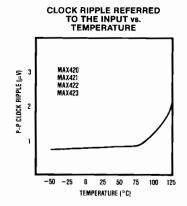




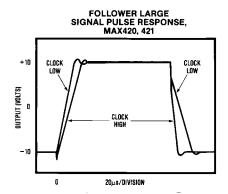


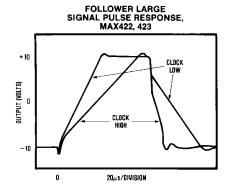


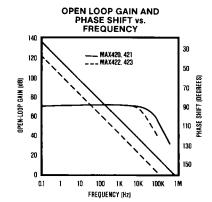




Typical Operating Characteristics







Detailed Description

Amplifier Operation

A block diagram of a MAX420 series amplifier is shown in Figure 2. Internally there are two amplifiers, a main amp and a nulling amp. The main amplifier is in the primary signal path and is continuously connected to the external inputs. The null amp alternately corrects its own offset, and then that of the main amp, as its input switches between the two main amp inputs. Offset correction is accomplished by means of compensating FETs in the input stage's bias circuitry (not shown). The offset values that drive these trim FETs are stored for the duration of the correction cycle on two capacitors, C_{EXTA} and C_{EXTB} . Each cycle is controlled by the clock as shown in the timing diagram of Figure 2. An added benefit of the offset correction scheme is that it also increases CMRR, PSRR, and A_{VOL} at low frequencies ($f_{\text{IN}} \ll f_{\text{CLK}}$).

Capacitor Selection

Two external capacitors, C_{EXTA} and C_{EXTB} , connected as shown in Figure 1, enable the amplifier to store and correct its own offset errors. The MAX420 series is specified with $0.1\mu\text{F}$ capacitors, however, other values up to $1.0\mu\text{F}$ may be optimal if different clock rates are used (MAX421, 423 only). If an external clock is used, the capacitor values should be scaled to roughly maintain the ratio between the nominal self-clock period (2.5ms @ 400Hz) and $0.1\mu\text{F}$. For example, if a 200Hz clock were used, then $0.2\mu\text{F}$ would be best. This relationship is not critical and certainly no change in capacitor value is necessary for part-to-part variations in the internal clock rate.

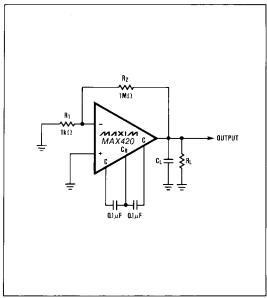


Figure 1. Test Circuit.

The banded or outer foil end of the correction capacitors should be connected to C_{RETN} as this is a low impedance point. C_{EXTA} and C_{EXTB} are high impedance nodes and so the connections to these pins should be as short as possible to minimize noise pick-up.

Capacitor Types

Precision DC performance can be realized with a wide variety of capacitor types, however those with high leakage will cause excessive clock ripple in the signal path and should not be used. Other low cost capacitors, such as ceramics, may have adequate leakage specifications but often also exhibit high dielectric absorption. This will not harm the amplifier's DC performance but can increase the initial settling time on turn-on to 1 or 2 seconds (to $1\mu V$). If fast settling after power-up is required then higher quality capacitors, such as mylar or polypropylene, should be used.

Clock

An on-chip clock is included on all 420 series amplifiers to control the operation of the offset correction circuitry. This oscillator is completely self contained and needs no external components or connections. The internal clock rate is nominaly 400Hz on the MAX420/421 and is 250Hz on the MAX422/423.

External Clock

The MAX421 and 423 have an INT/EXT pin for clock selection (pin 14). The pin has an internal pull-up and, for self-clocked operation, can be left open or connected

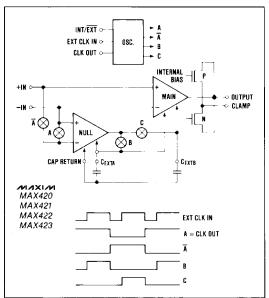


Figure 2. Maxim MAX420 Series Amplifier Block Diagram.

to V⁺. When INT/ \overline{EXT} is tied to V⁻ the internal clock is disabled and an external clock can then be applied to EXT CLK IN. Because of an internal divider, the offset nulling circuitry runs at one half the external clock rate.

Duty Cycle and Thresholds

The duty cycle of the external clock is not critical at low frequencies. For EXT CLK IN frequencies of 500Hz or greater, a 50% to 80% positive duty cycle is recommended to allow transients on the null capacitors to settle. This is necessary because the capacitors are only charged when EXT CLK IN is high. The input threshold for EXT CLK IN is typically V⁺ – 2.5V so that an external clock signal can swing from either V⁺ to GROUND or V⁺ to V⁻. The internal chopping frequency is available at the CLK OUT pin with either internal or external clock operation .The nominal output levels for CLK OUT are V⁺ for a "High" and V⁺ – 5V for a clock "I ow"

In some instances, it may be advantageous to synchronize two amplifier clocks, or slave one to another. A simple way to accomplish this is to tie the amplifiers' EXT CLK IN pins together (MAX421 or 423 only) and pull one's INT/EXT pin low while allowing the other's to float high. The amplifier with INT/EXT high will then provide the clock for both devices (see Figure 9).

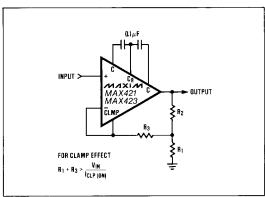


Figure 3. Non-Inverting Amplifier with Optional Clamp.

Plugging into a Conventional Op-Amp Socket

As a result of their $\pm 15V$ supply capability, the 8-pin MAX420 and 422 can plug directly into a conventional op-amp socket for immediate upgrading of DC specifications. Since the external nulling capacitors occupy what are usually "Offset null" pins (1, 5, and 8), the standard op-amp pin-out is still maintained for input, output, and supply connections. Essentially, C_{EXTA} and C_{EXTB} replace the offset trim pot normally required with conventional op-amps.

Output Clamp/Overload

The OUTPUT CLAMP, when connected to the inverting input, reduces the amplifier's overload recovery time (see Figures 3 and 4). It does this by providing a feedback path that is activated just before the output saturates. The resultant reduction in gain prevents differential input overload and consequent charge build-up on the correction capacitors. If the capacitors are allowed to overcharge, the amplifier will need time to recover (typically 500ms) after the overload is removed. Since the OUTPUT CLAMP activates slightly prior to output saturation there is also a small reduction in output swing when it is used. This reduction is typically 500mV with a $10 k\Omega$ output load.

Single Supply Operation

The 420 series amplifiers are well suited for operation in single power supply applications that have system ground connected to V⁻. With supply voltages of 10 volts or above the input range is typically from Ground to V⁺ – 1.5V. At lower supply voltages the input-range lower limit will be higher (approx. Gnd + 0.5V at 5V supply). The amplifiers' outputs will swing to within approximately 50mV of Ground or V⁺ with a $100 \mathrm{k}\Omega$ load and within $500 \mathrm{m}V$ with $10 \mathrm{k}\Omega$ (MAX420, 421 only).

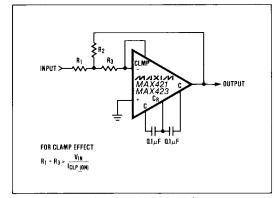


Figure 4. Inverting Amplifier with Optional Clamp.

____ Applications Low Voltage Signals

Realizing microvolt offset and nanovolt drift performance goes beyond the selection of a precision amplifier (though it's not a bad start). When trying to amplify very low level signals any number of outside error sources can confuse the measurement. These errors are often indistinguishable from real signal or amplifier error, which of course is why they are a problem.

Thermo-Electric Effect

This property describes how thermocouples measure temperature. In short it states that two dissimilar metals in contact can be expected to generate a voltage. This is fine for thermocouples but is not so useful when pin-to-socket, socket-to-circuit board, and circuit board-to-edge connector junctions all generate signals which can add to input error. The voltage generated in such situations can range from 0.1 to 10's of $\mu\text{V/}^{\circ}\text{C}$, many times the offset drift of an MAX420. In general such problems are dealt with by minimizing sockets and connectors in low level circuitry and by using components designed for low thermal EMF when connectors, relays, etc. are unavoidable.

Gradients

The presence of heat in low level circuitry is often not so much a problem as are thermal gradients. Gradients can, for example, cause normally balanced amplifier input connections to be at different temperatures. These connections then generate different thermoelectric voltages that can no longer be completely cancelled by the balanced inputs. The moral then is to minimize thermal gradients by keeping power dissipation and air currents in and around low level circuitry and connections at a minimum.

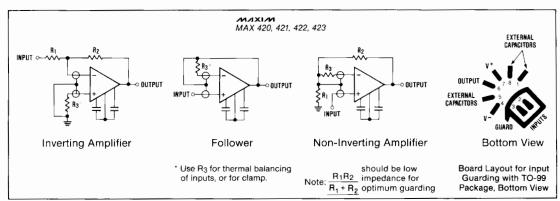


Figure 5. Input Guard Connections.

Thermal Symmetry

Another useful low level technique is to design thermal "symmetry" into the layout. This may mean adding dummy resistors and connections so that the thermal mass, as well as the number of thermoelectric error sources, in an input pair will cancel. It may also involve running input traces near each other and keeping their size the same as well. Thermal "filtering" with small enclosures or even insulation for sensitive areas can also be helpful.

Low Current Signals, Input Guards

Low leakage, high impedance CMOS inputs allow the MAX420 amplifier family to amplify the signals of very high impedance sources. Though the amplifiers' input bias current is measured in picoamps, getting the surrounding connections to live up to that specification requires some attention. In applications where picoamp or nanoamp errors can be significant, board leakage either from surface contamination or through the board material itself may be a problem.

Controlling Leakage

Using low leakage board materials and proper cleaning methods after assembly can provide marked reductions in leakage induced errors. Beyond this, conformal coatings can be used to control later surface contamination. In some cases, Teflon insulators and/or circuit board guard rings may be necessary to protect very high impedance nodes. Guard connections for various amplifier configurations are shown in Figure 5. In each case the guard is connected to a low impedance point that is approximately at the same potential as the inputs. Leakage currents from other points on the board are then absorbed by the guard. For best results, guard rings should be used on both sides of the circuit board. The 14 pin MAX421 and 423 have specifically been designed to ease input guard layout in that the pins adjacent to the inputs are unused in those packages.

Output Characteristics / Open Loop Gain

The MAX420 and 421 can typically drive a 10k Ω load from +14.8V to -14.5V when operating with \pm 15V power supplies. With a 100k Ω or greater load, however, the output can typically swing to within 50mV of each rail. The output swing with the lower power MAX422 and 423 will be somewhat less for a given load.

The open loop gain of a MAX420 series amplifier is somewhat load dependent for resistances which are less than $10k\Omega.$ The effect is largely due to the impedance of the amplifier's output stage. The gain is about 17dB lower with a $1k\Omega$ load than it is with $10k\Omega.$ Since even with $1k\Omega$ the gain is still typically 120dB, the reduction is insignificant for low frequency applications. In wideband circuits, however, the best results are achieved with loads of $10k\Omega$ or more where the amplifier's open loop response is a smooth 6dB/octave slope from 0.1Hz to 0.5MHz. Additionally, there is negligible phase shift at the frequency where the null amp is rolled off.

Intermodulation

In some chopper-stabilized amplifier designs, interaction between the input signal and the chopper frequency sometimes produces intermodulation products in the form of sum and difference signals. If the input frequency and the chop rate are near enough to each other, a difference signal may even appear as a DC error at the output. The MAX420 series minimizes these problems with active compensation circuitry that virtually eliminates intermodulation effects and controls the amplifier's open loop gain-phase characteristics as well. With well behaved open loop parameters, the chopper circuitry's impact on the amplifier's dynamic performance can be ignored in most applications.

Typical Applications

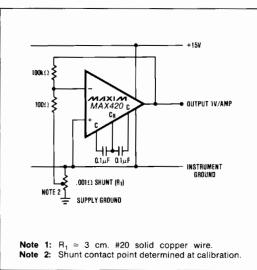


Figure 6. Ultra-low Current Shunt Amp.

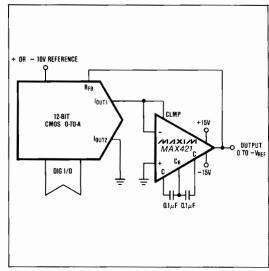


Figure 7. CMOS DAC Output Amplifier. Low offset maintains DAC linearity.

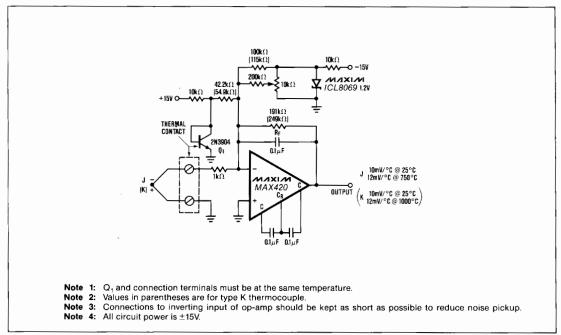


Figure 8. Amplifier with Cold-Junction Compensation for Grounded Thermocouples.

Typical Applications

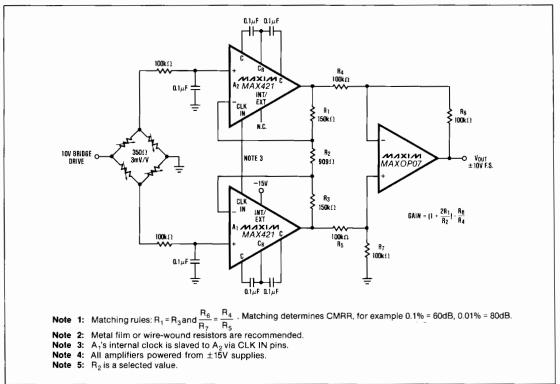


Figure 9. $10\mu V V_{OS}$, $0.1\mu V/^{\circ}C$ Strain Gauge Instrumentation Amplifier.

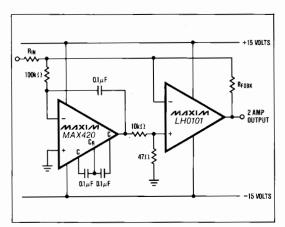
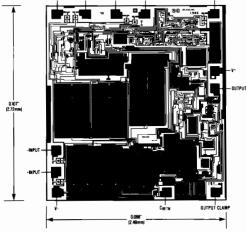


Figure 10. D.C. Stabilized Power Op-Amp. Main amp has 5MHz

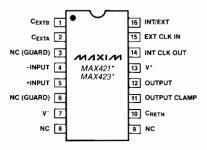
Chip Topography



_ Ordering Information (continued)

PART	TEMP. RANGE	PACKAGE
MAX421M/D	-55°C to +125°C	Dice
MAX422CPA	0°C to +70°C	8 Lead Plastic DIP
MAX422EPA	-40°C to +85°C	8 Lead Plastic DIP
MAX422MTV	-55°C to +125°C	TO-99 Metal Can
MAX423CPD	0°C to +70°C	14 Lead Plastic DIP
MAX423CWE	0°C to +70°C	16 Lead Small Outline
MAX423C/D	0°C to +70°C	Dice
MAX423EPD	-40°C to +85°C	14 Lead Plastic DIP
MAX423MJD	-55°C to +125°C	14 Lead CERDIP
MAX423M/D	-55°C to +125°C	Dice

_ Pin Configurations (continued)



NC = No internal connection

* Pinout for small outline package only